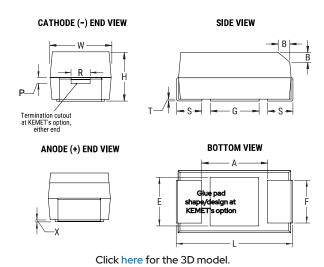


T540D686M016AH6510

Aliases (DLA Drawing 04051-035MZ)

T540 HRA, Tantalum, Polymer Tantalum, HRA, 68 uF, 20%, 16 VDC, SMD, Polymer, Molded, High Reliability, N/A, 75 mOhms, 3.1 mm, 1.3 mm, 2817 / 7343



General Information		
Series	T540 HRA	
Dielectric	Polymer Tantalum	
Style	SMD Chip	
Description	SMD, Polymer, Molded, High Reliability	
Features	Non-Combustible, Low ESR, High Reliability	
RoHS	No	
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov /	
SCIP Number	b064b03e-bd75-42af-b342-1fe 94dec2340	
Termination	Tin Lead (SnPb)	
Qualifications	DLA Drawing 04051	
AEC-Q200	No	
Typical Component Weight	352.36 mg	
Shelf Life	52 Weeks	
MSL	3	

68 uF

20%

-55/+125°C 105°C

voltage

2000 Hrs (125C)

10% 120Hz 25C

16 VDC (105C), 10.72 VDC (125C)

60C, 90% RH, 500 Hours, rated

Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	2.8mm +/-0.3mm
Т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
В	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
P	0.9mm REF
R	1mm REF
Х	0.1mm +/-0.1mm REF

500

Packaging Quantity

E	3.5IIIIII REF		
_		Failure Rate	N/A
G	3.5mm REF	ESR	75 mOhms (100kHz 25C)
P	0.9mm REF	LSIX	75 111011113 (100K1 12 25C)
R	1mm REF	Ripple Current	1732 mA (rms, 100kHz 45C)
R	IMM REF	Leakage Current	109 uA (5min 25°C)
X	0.1mm +/-0.1mm REF	_canage can one	
	Testing and Reliability	4 Cycles At +25C +/-5C Before Voltage Aging	
Packaging Specifications			
Packaging	T&R, 178mm		

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Specifications
Capacitance

Tolerance

Voltage DC

Life

Humidity

Temperature Range

Rated Temperature

Dissipation Factor

Generated 11/04/2025 © 2006 - 2025 YAGEO



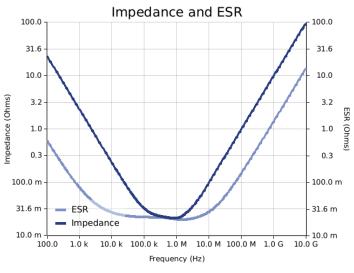
T540D686M016AH6510

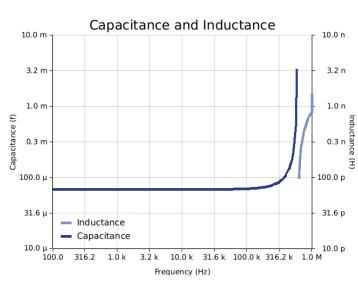
Aliases (DLA Drawing 04051-035MZ)

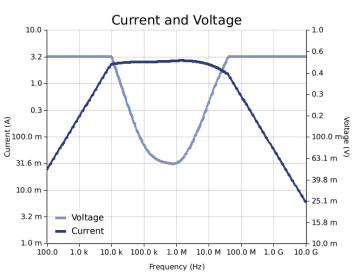
T540 HRA, Tantalum, Polymer Tantalum, HRA, 68 uF, 20%, 16 VDC, SMD, Polymer, Molded, High Reliability, N/A, 75 mOhms, 3.1 mm, 1.3 mm, 2817 /

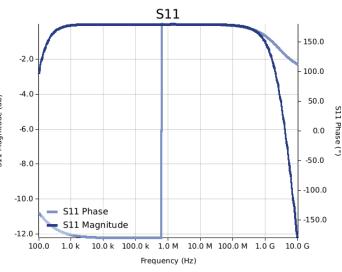
Simulations

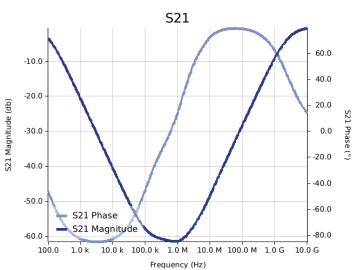
For the complete simulation environment please visit Y-SIM.











Generated 11/04/2025 © 2006 - 2025 YAGEO



T540D686M016AH6510

Aliases (DLA Drawing 04051-035MZ)

T540 HRA, Tantalum, Polymer Tantalum, HRA, 68 uF, 20%, 16 VDC, SMD, Polymer, Molded, High Reliability, N/A, 75 mOhms, 3.1 mm, 1.3 mm, 2817 /

These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR is the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated. The effects shown herein are based on measured data from a multiple part sample of the parts in question.

 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages
- generated at any other harmonics.

 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.

Generated 11/04/2025 © 2006 - 2025 YAGEO